

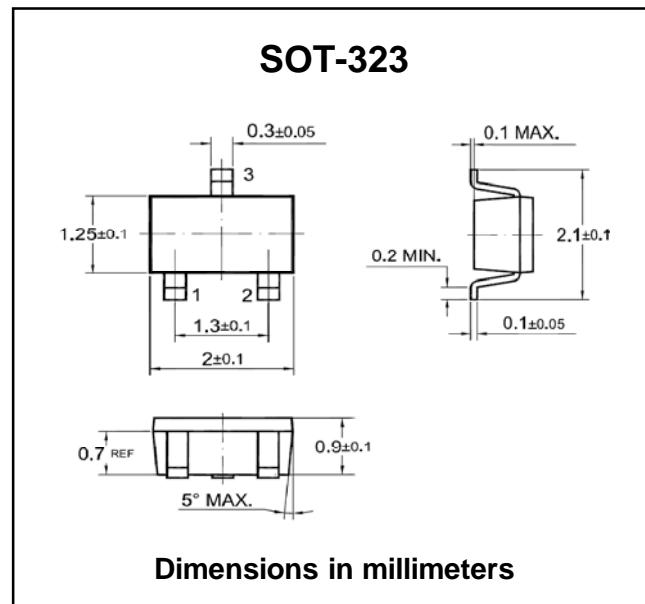
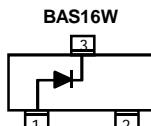
BAS16W

SILICON EPITAXIAL PLANAR SWITCHING DIODE

For high speed switching applications

MECHANICAL DATA :

- * Case : SOT-323 plastic Case
- * Marking code : A6



ABSOLUTE MAXIMUM RATING (Ta = 25 °C)

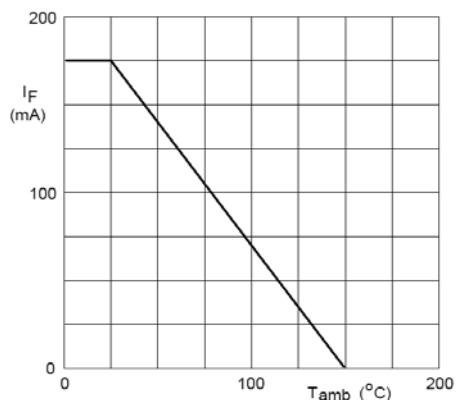
Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	85	V
Continuous Reverse Voltage	V _R	75	V
Continuous Forward Current	I _F	155	mA
Repetitive Peak Forward Current	I _{FRM}	500	mA
Non-repetitive Peak	I _{FSM}	4.5	A
Forward Surge Current		1.0	
t = 1 s		0.5	
Power Dissipation	P _{tot}	200	mW
Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

Parameter	Test Condition	Symbol	Min.	Typ.	Max.	Unit
Forward Voltage	I _F = 1 mA	V _F	-	-	715	mV
	I _F = 10 mA		-	-	855	mV
	I _F = 50 mA		-	-	1.00	V
	I _F = 150 mA		-	-	1.25	V
Reverse Current	V _R = 25 V	I _R	-	-	30	nA
	V _R = 75 V		-	-	1.0	µA
	V _R = 25 V, T _j = 150 °C		-	-	30	µA
	V _R = 75 V, T _j = 150 °C		-	-	50	µA
Diode Capacitance	V _R = 0 V, f = 1 MHz	C _D	-	-	1.5	pF
Reverse Recovery Time	I _F = 10mA, VR = 6 V, Irr = 1 mA, R _L = 100 Ω:	Tr _r	-	-	4	ns

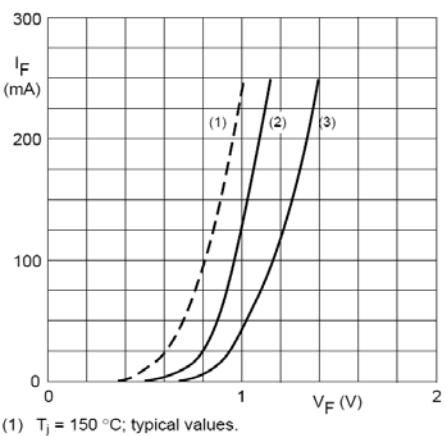
RATINGS AND CHARACTERISTIC CURVES (BAS16W)

FIG.1 - Maximum permissible continuous forward current as a function of ambient temperature.



Device mounted on an FR4 printed-circuit board.

FIG.2 - Forward current as a function of forward voltage.



- (1) $T_j = 150 \text{ } ^\circ\text{C}$; typical values.
- (2) $T_j = 25 \text{ } ^\circ\text{C}$; typical values.
- (3) $T_j = 25 \text{ } ^\circ\text{C}$; maximum values.

FIG.3 - Reverse current as a function of junction temperature

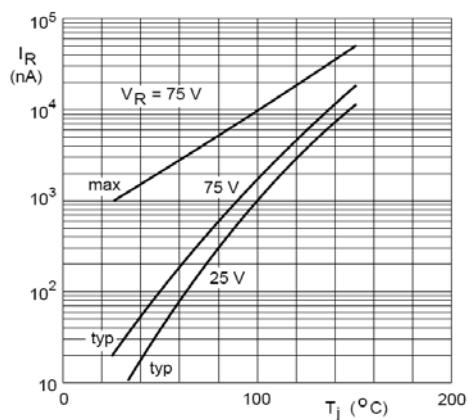


FIG.4 - Diode capacitance as a function of reverse voltage; typical values

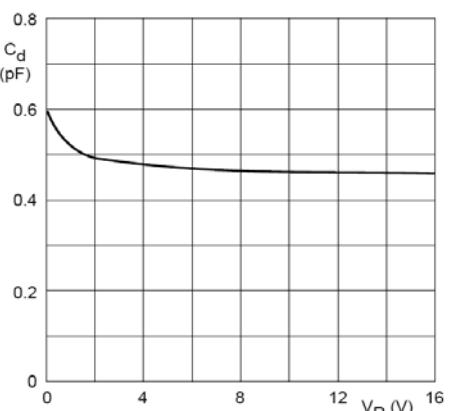
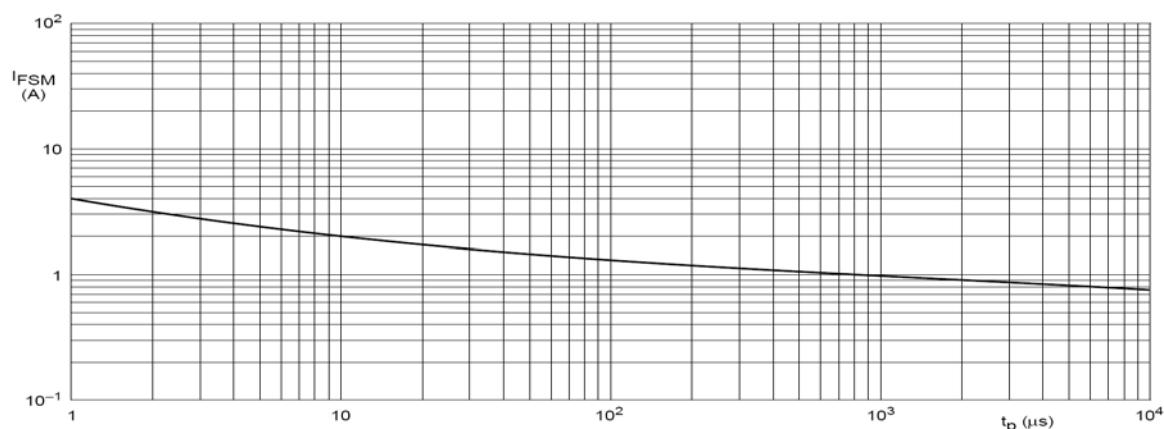


FIG.5 - Maximum permissible non-repetitive peak forward current as a function of pulse duration



Based on square wave currents.
 $T_j = 25 \text{ } ^\circ\text{C}$ prior to surge.